

檔 號：

保存年限：

台灣美光記憶體股份有限公司 函

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受文者： 國立清華大學

發文日期： 中華民國 104 年 02 月 05 日

發文字號： (104)美光字第 0017 號

速 別： 速件

密件及解密條件： 普通

附件： Scholarship Agreement 2 份；台灣美光獎學金實施辦法 1 份；台灣美光獎學金申請表 1 份。

主旨： 檢送「台灣美光獎學金」實施辦法暨相關申請書表如附件，敬請配合完成簽約並惠予公告推薦 貴校符合資格之優秀學生申請為禱。

說明： 一、獎學金合約(Scholarship Agreement)由 貴校直接與美光科技基金會(Micron Technology Foundation, Inc.) 逐年議訂，貴校核定函附首年度合約文本後，請簽署擲回正本乙份予本公司作為實施本案獎學金之依據。

二、貴校今(104)年度得於 3 月 31 日前送出 4 名入選者(建議可依院所情況由理學院推薦 1 名、工學院推薦 2 名及電資學院推薦 1 名學生)及其申請文件給本公司，經本公司審查資格無誤後，於 4 月公佈獲獎學生名單。

總經理 陳正坤

正本： 國立清華大學學務處生輔組

副本：



台灣美光獎學金實施辦法

一、宗旨：為支持台灣教育事業培育科技人才，鼓勵優秀學子敦品向學，致力於科技領域之研究，特訂定本辦法，以獎助在學期間表現優異學生。

二、申請資格：

- (一) 國立台灣大學、國立清華大學、國立成功大學及國立中興大學，理、工及電資學院之電子/電機/機械/物理/化學/化工/材料/資工/環工/工業工程等相關系所。
- (二) 大學三、四年級及碩士班一、二年級在學學生，品行端正、無不良紀錄者。
- (三) 前一學年操行成績及學業成績平均80分以上，且學業成績達全班前20%者。
- (四) 曾修習半導體相關課程或撰寫半導體相關專題及論文研究，將優先考慮。

三、獎學金金額：每名每年新台幣 9 萬元。(獎學金預算於每年年初編列，實際撥付金額可能因匯率變動而有差異，依預算金額為準。)

四、申請文件：

- (一) 台灣美光獎學金申請表。
- (二) 前一學年學業成績單正本。(如現為碩一，請提供大四上學期及下學期之學業成績單，且大學與研究所須為同所學校。)
- (三) 自述書(自我介紹、年度學習計劃、未來生涯規劃與發展等，不限格式)。
- (四) 專題、論文概要，或其它各類優秀著作與作品之佐證影本。

五、申請方式：依各校公告截止日期前，檢附申請文件至各校專責業務單位辦理。

六、遴選：

凡符合申請資格且備齊申請文件者，經各校於 3 月 31 日前送出最後 4 名入選者及其申請文件給本公司，經本公司審查資格無誤後，於 4 月公布獲獎名單。

七、其它：

- (一) 本獎學金一年受理申請一次，核定後由本公司全額匯款至學校指定之帳號，由學校轉匯給獲獎學生。
- (二) 經核定獲獎之學生，如有休學、退學之事實，將喪失獎助資格。
- (三) 獲獎學生務必出席由本公司邀請之廠內觀摩交流活動。
- (四) 獲獎學生應保證其專題或論文著作無侵害他人權利，如有違反，應自負一切法律責任。
- (五) 本辦法未規範之事宜或與 Scholarship Agreement 內容不一致者，以 Scholarship Agreement 為準。



台灣美光獎學金申請表

申請日期：西元 年 月 日

姓 名	中 文		身 分 證 字 號 (非本國籍請填 護 照 號 碼)	
	英 文		出 生 日 期	西元 年 月 日
學校名稱				年 級 ☐ 大學部____年級 ☐ 碩士生____年級
科系名稱				
E-mail				性 別 ☐ 男 ☐ 女
戶籍地址				住 家 電 話
通訊地址				行 動 電 話

是否曾申請本獎學金？ ☐ 否 ☐ 是，申請學年度：_____，獲獎次數_____次

前 一 學 年 成 績	上 學 期	操行：_____分	學業平均成績：_____分	排名：_____/_____(名次/班級人數)
	下 學 期	操行：_____分	學業平均成績：_____分	排名：_____/_____(名次/班級人數)

修習半導體相關課程、專題、論文研究或其他特殊績優表現之說明：

Scholarship Agreement

This Scholarship Agreement ("**Agreement**") is made effective as of [REDACTED] by and between the Micron Technology Foundation, Inc. (the "**Foundation**") and National Tsing Hua University (the "**University**").

Whereas, the Foundation is an Idaho non-profit corporation which is exempt from federal income taxes under section 501(c)(3) of the Internal Revenue Code and which has as one of its goals the improvement of educational opportunities; and

Whereas, the University is an institution of higher learning; and

Whereas, the Foundation wishes to provide, and the University wishes to accept, funding of academic scholarships by the Foundation on the terms and conditions described herein;

Now, therefore, it is agreed as follows:

1. **The Gifts.** The Foundation will provide periodic cash gifts to the University so that the University may provide scholarships to students studying at the University (the "**Scholarships**"). Prior to each academic year, the Foundation will send a letter to the University which:
 - References this Agreement
 - Provides the amount the Foundation will gift to the University for Scholarships in the upcoming academic year. The Foundation is not required to provide a gift every year.
 - Provides the eligibility qualifications for the Scholarship (e.g. eligible majors, minimum GPA, etc.)

The Scholarship funds shall be used for tuition, books, fees and similar expenses incurred to attend the University. Any tax withholding obligation imposed on the Scholarship payments by any applicable tax authority shall be the responsibility of the University.

2. **Award of Scholarship.** The Scholarships will be awarded by a University-designated committee which includes representation from the departments responsible for the majors eligible for the Scholarships.

3. **Name of Scholarship.** Recipients of the Scholarships will be known as “**Micron Scholars**” and will be described as such in any written materials (e.g. announcements, applications, certificates, etc.) related to the Scholarships.
4. **Records/Foundation Outreach/Unused Funds.** The University shall keep an account of each Scholarship, including the recipient’s name, email address, physical address, application materials and academic standing. This information shall be made available to the Foundation upon request and the University shall obtain any consent necessary from the Scholarship recipients for this purpose. The Foundation may reach out to Scholarship recipients to offer congratulations, information about the Foundation and topics of interest, and small gifts (e.g. water bottles, t-shirts, usb memory devices, etc.).

Funds which are unused because a recipient departs school or is otherwise no longer eligible for the Scholarship will be used in the following academic year for future Scholarships, unless the Agreement is terminated as provided below.

5. **Termination; Final Accounting.** The Foundation reserves the right to review the conditions and procedures of this Scholarship program and to make changes at any time, including termination of this Agreement or any individual Scholarship upon written notice to University. If an individual Scholarship is terminated, the University shall make no further Scholarship payments to such individual. If this Agreement is terminated, then it shall expire once there are no longer any pending Scholarship payments. Promptly after making the final payment to the Scholarship recipients, the University shall provide a final accounting of the Scholarship funds to the Foundation. Any remaining funds shall be used by the University to improve educational opportunities in a manner mutually agreed upon by the Foundation and the University.
6. **Applicable Law.** The validity, interpretation and performance of this Agreement shall be governed by and construed in accordance with the federal laws and the laws of the State of Idaho without giving effect to such State’s conflict of laws principles. University hereby consents to the jurisdiction of courts within the State of Idaho for any dispute involving this Agreement.
7. **Waiver.** Any waiver of any kind by a party of a breach of this Agreement must be in writing, shall be effective only to the extent set forth in such writing and shall not operate or be construed as a waiver of any subsequent breach. Any delay or omission in exercising any right, power or remedy pursuant to a breach or default by a party shall not impair any right, power or remedy which either party may have with respect to a future breach or default.

8. **Counterparts/Facsimiles.** This Agreement may be executed in any number of counterpart originals, each of which shall be deemed an original instrument for all purposes, but all of which shall comprise one and the same instrument. This Agreement may be delivered by facsimile and a facsimile of this Agreement shall be binding as an original.
9. **Entire Agreement.** This Agreement supersedes and replaces any prior oral or written understandings or communications between the Foundation and University concerning scholarships. It constitutes the entire agreement of the Foundation and University regarding this grant. This Agreement and the terms of the Scholarships may not be amended or modified, except in a writing signed by both the Foundation and University.

IN WITNESS WHEREOF, the Foundation and University have executed this Agreement.

Micron Technology Foundation, Inc.

National Tsing Hua University

By: _____
Name: _____
Title: _____

By: _____
Name: _____
Title: _____